# INTEGRATED CIRCUITS



Product specification Supersedes data of 1996 Sep 10 IC23 Data Handbook

1998 Jan 16



Philips Semiconductors



74ABT541

#### **FEATURES**

- Octal bus interface
- Functions similar to the 'ABT241
- Provides ideal interface and increases fan-out of MOS Microprocessors
- Efficient pinout to facilitate PC board layout
- 3-State buffer outputs sink 64mA and source 32mA
- Power-up 3-State
- Latch-up protection exceeds 500mA per Jedec JC40.2 Std 17

- ESD protection exceeds 2000 V per MIL STD 883 Method 3015 and 200 V per Machine Model
- Live insertion/extraction permitted

#### DESCRIPTION

The 74ABT541 high-performance BiCMOS device combines low static and dynamic power dissipation with high speed and high output drive.

The 74ABT541 device is an octal buffer that is ideal for driving bus lines. The outputs are all capable of sinking 64mA and sourcing 32mA. The device features input and outputs on opposite sides of the package to facilitate printed circuit board layout.

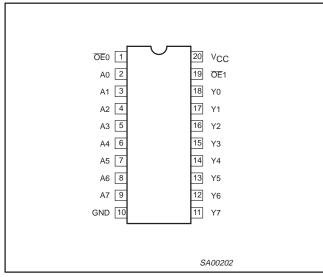
#### QUICK REFERENCE DATA

SYMBOL	PARAMETER	PARAMETER CONDITIONS T <sub>amb</sub> = 25°C; GND = 0V			
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation delay An to Yn	C <sub>L</sub> = 50pF; V <sub>CC</sub> = 5V	2.9	ns	
C <sub>IN</sub>	Input capacitance	$V_I = 0V \text{ or } V_{CC}$	4	pF	
C <sub>OUT</sub>	Output capacitance	Outputs disabled; $V_O = 0V$ or $V_{CC}$	7	pF	
I <sub>CCZ</sub>	Total supply current	Outputs disabled; $V_{CC} = 5.5V$	500	nA	

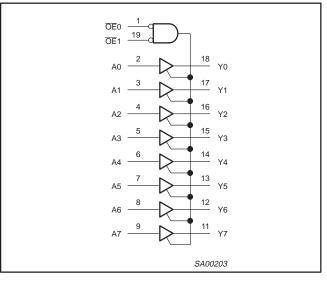
#### **ORDERING INFORMATION**

PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	DWG NUMBER
20-Pin Plastic DIP	–40°C to +85°C	74ABT541 N	74ABT541 N	SOT146-1
20-Pin plastic SO	–40°C to +85°C	74ABT541 D	74ABT541 D	SOT163-1
20-Pin Plastic SSOP Type II	–40°C to +85°C	74ABT541 DB	74ABT541 DB	SOT339-1
20-Pin Plastic TSSOP Type I	–40°C to +85°C	74ABT541 PW	74ABT541PW DH	SOT360-1

#### **PIN CONFIGURATION**

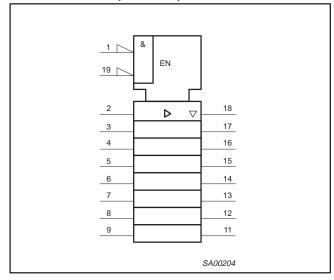


LOGIC SYMBOL



### 74ABT541

#### LOGIC SYMBOL (IEEE/IEC)



#### **PIN DESCRIPTION**

PIN NUMBER	SYMBOL	NAME AND FUNCTION	
2, 3, 4, 5, 6, 7, 8, 9	A0 – A7	Data inputs	
18, 17, 16, 15, 14, 13, 12, 11	Y0 – Y7	Data outputs	
1, 19	<u>OE</u> 0, <u>OE</u> 1	Output enables	
10	GND	Ground (0V)	
20	V <sub>CC</sub>	Positive supply voltage	

#### **FUNCTION TABLE**

	INPUTS		OUTPUTS
OE0	OE1	An	Yn
L L X H	L L H X	L H X X	L H Z Z

H = High voltage level

L = Low voltage level

X = Don't care Z = High impedance "off" state

#### **ABSOLUTE MAXIMUM RATINGS<sup>1, 2</sup>**

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V <sub>CC</sub>	DC supply voltage		-0.5 to +7.0	V
I <sub>IK</sub>	DC input diode current	V <sub>1</sub> < 0	-18	mA
VI	DC input voltage <sup>3</sup>		-1.2 to +7.0	V
I <sub>OK</sub>	DC output diode current	V <sub>O</sub> < 0	-50	mA
V <sub>OUT</sub>	DC output voltage <sup>3</sup>	output in Off or High state	-0.5 to +5.5	V
I <sub>OUT</sub>	DC output current	output in Low state	128	mA
T <sub>stg</sub>	Storage temperature range		-65 to 150	°C

NOTES:

1. Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

2. The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 150°C.

3. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

74ABT541

#### **RECOMMENDED OPERATING CONDITIONS**

SYMBOL	PARAMETER	LIM	ITS	UNIT
		Min	Max	1
V <sub>CC</sub>	DC supply voltage	4.5	5.5	V
VI	Input voltage	0	V <sub>CC</sub>	V
V <sub>IH</sub>	High-level input voltage	2.0		V
V <sub>IL</sub>	Low-level Input voltage		0.8	V
I <sub>ОН</sub>	High-level output current		-32	mA
I <sub>OL</sub>	Low-level output current		64	mA
Δt/Δv	Input transition rise or fall rate	0	5	ns/V
T <sub>amb</sub>	Operating free-air temperature range	-40	+85	°C

#### DC ELECTRICAL CHARACTERISTICS

					LIMITS			
SYMBOL	PARAMETER	TEST CONDITIONS	Ta	<sub>mb</sub> = +25	°C		-40°C 85°C	UNIT
			Min	Тур	Max	Min	Max	1
V <sub>IK</sub>	Input clamp voltage	$V_{CC} = 4.5V; I_{IK} = -18mA$		-0.9	-1.2		-1.2	V
		$V_{CC}$ = 4.5V; $I_{OH}$ = –3mA; $V_{I}$ = $V_{IL}$ or $V_{IH}$	2.5	2.9		2.5		V
V <sub>OH</sub>	High-level output voltage	$V_{CC}$ = 5.0V; $I_{OH}$ = -3mA; $V_I$ = $V_{IL}$ or $V_{IH}$	3.0	3.4		3.0		V
		$V_{CC}$ = 4.5V; $I_{OH}$ = -32mA; $V_{I}$ = $V_{IL}$ or $V_{IH}$	2.0	2.4		2.0		V
V <sub>OL</sub>	Low-level output voltage	$V_{CC}$ = 4.5V; $I_{OL}$ = 64mA; $V_{I}$ = $V_{IL}$ or $V_{IH}$		0.42	0.55		0.55	V
l <sub>l</sub>	Input leakage current	$V_{CC}$ = 5.5V; $V_{I}$ = GND or 5.5V		±0.01	±1.0		±1.0	μΑ
I <sub>OFF</sub>	Power-off leakage current	$V_{CC}$ = 0.0V; $V_{I}$ or $V_{O}$ $\leq$ 4.5V		±5.0	±100		±100	μΑ
I <sub>PU</sub> /I <sub>PD</sub>	Power-up/down 3-state output current <sup>3</sup>	$V_{CC}$ = 2.0V; $V_{O}$ = 0.5V; $V_{I}$ = GND or $V_{CC};$ $V_{OE}$ = Don't care		±5.0	±50		±50	μA
I <sub>OZH</sub>	3-State output High current	$V_{CC}$ = 5.5V; $V_{O}$ = 2.7V; $V_{I}$ = $V_{IL}$ or $V_{IH}$		5.0	50		50	μΑ
I <sub>OZL</sub>	3-State output Low current	$V_{CC}$ = 5.5V; $V_{O}$ = 0.5V; $V_{I}$ = $V_{IL}$ or $V_{IH}$		-5.0	-50		-50	μΑ
I <sub>CEX</sub>	Output High leakage current	$V_{CC}$ = 5.5V; $V_{O}$ = 5.5V; $V_{I}$ = GND or $V_{CC}$		5.0	50		50	μΑ
Ι <sub>Ο</sub>	Output current <sup>1</sup>	$V_{CC} = 5.5V; V_{O} = 2.5V$	-40	-100	-180	-40	-180	mA
I <sub>CCH</sub>		$V_{CC}$ = 5.5V; Outputs High, $V_{I}$ = GND or $V_{CC}$		0.5	250		250	μΑ
I <sub>CCL</sub>	Quiescent supply current	$V_{CC}$ = 5.5V; Outputs Low, $V_{I}$ = GND or $V_{CC}$		24	30		30	mA
I <sub>CCZ</sub>		$V_{CC}$ = 5.5V; Outputs 3-State; V <sub>I</sub> = GND or V <sub>CC</sub>		0.5	250		250	μΑ
		Outputs enabled, one input at 3.4V, other inputs at V <sub>CC</sub> or GND; $V_{CC} = 5.5V$		0.5	1.5		1.5	mA
$\Delta I_{CC}$	Additional supply current per input pin <sup>2</sup>	Outputs 3-State, one data input at 3.4V, other inputs at $V_{CC}$ or GND; $V_{CC} = 5.5V$		0.5	50		50	μΑ
		Outputs 3-State, one enable input at 3.4V, other inputs at $V_{CC}$ or GND; $V_{CC} = 5.5V$		0.5	1.5		1.5	mA

#### NOTES:

Not more than one output should be tested at a time, and the duration of the test should not exceed one second.
This is the increase in supply current for each input at 3.4V.
This parameter is valid for any V<sub>CC</sub> between 0V and 2.1V with a transition time of up to 10msec. For V<sub>CC</sub> = 2.1V to V<sub>CC</sub> = 5V ± 10%, a transition time of up to 100µsec is permitted.

74ABT541

Product specification

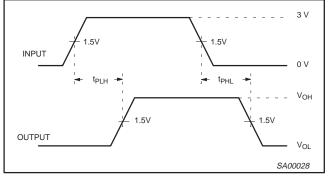
#### AC CHARACTERISTICS

GND = 0V;  $t_R = t_F = 2.5 \text{ns}$ ;  $C_L = 50 \text{pF}$ ,  $R_L = 500 \Omega$ 

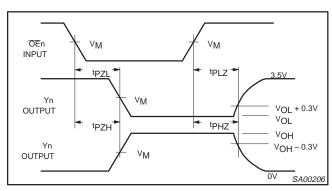
					LIMIT	s	S			
SYMBOL	PARAMETER	WAVEFORM	T <sub>é</sub> V	amb = +25° ′ <sub>CC</sub> = +5.0′	C V	$T_{amb} = -40^{\circ}$ $V_{CC} = +5.$	°C to +85°C .0V ±0.5V	UNIT		
			Min	Тур	Мах	Min	Max			
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation delay An to Yn	1	1.0 1.0	2.6 2.9	4.1 4.2	1.0 1.0	4.6 4.6	ns		
t <sub>PZH</sub> t <sub>PZL</sub>	Output enable time to High and Low level	2	1.1 2.1	3.1 4.4	4.8 5.9	1.1 2.1	5.3 6.4	ns		
t <sub>PHZ</sub> t <sub>PLZ</sub>	Output disable time from High and Low level	2	2.1 1.7	5.1 4.7	6.6 6.2	2.1 1.7	7.1 6.7	ns		

#### **AC WAVEFORMS**

 $V_{M} = 1.5V, V_{IN} = GND \text{ to } 3.0V$ 

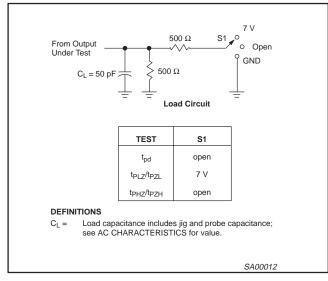


Waveform 1. Waveforms Showing the Input (An) to Output (Yn) Propagation Delays



Waveform 2. Waveforms Showing the 3-State Output Enable and Disable Times

#### **TEST CIRCUIT AND WAVEFORMS**

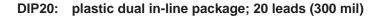


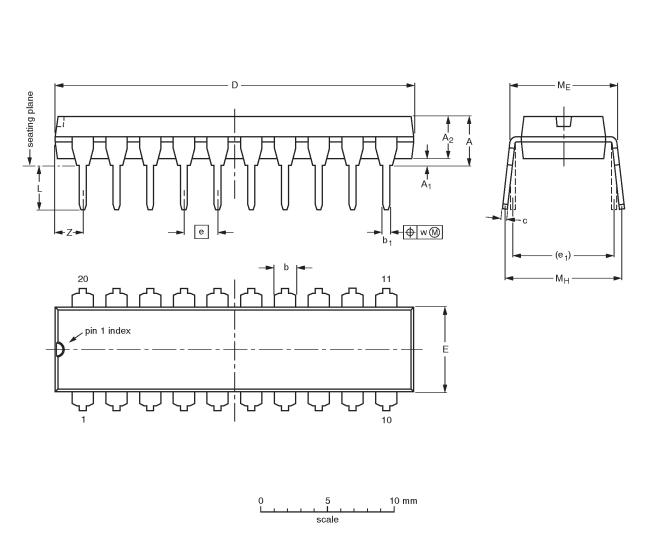
#### Product specification

SOT146-1

# Octal buffer/line driver (3-State)

## 74ABT541





#### DIMENSIONS (inch dimensions are derived from the original mm dimensions)

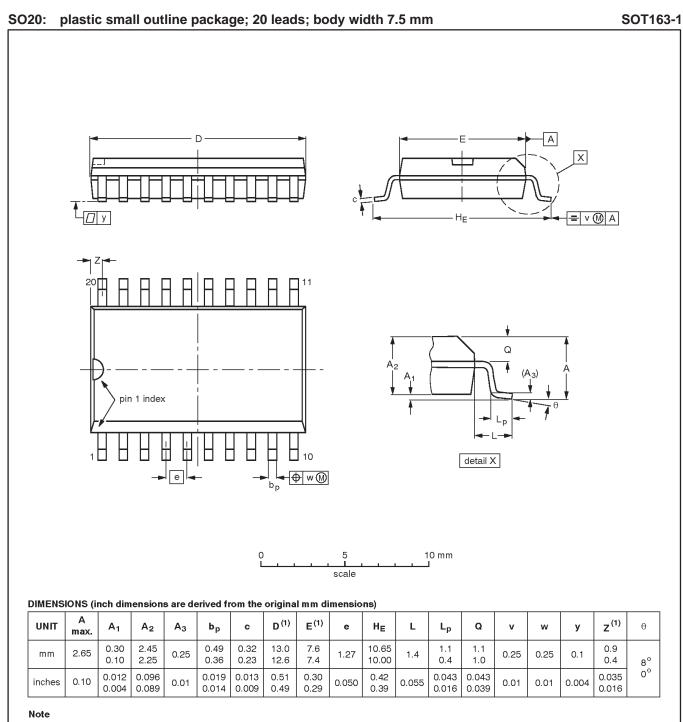
UNIT	A max.	A <sub>1</sub> min.	A <sub>2</sub> max.	b	b <sub>1</sub>	с	D <sup>(1)</sup>	E <sup>(1)</sup>	e	e <sub>1</sub>	L	M <sub>E</sub>	M <sub>H</sub>	w	Z <sup>(1)</sup> max.
mm	4.2	0.51	3.2	1.73 1.30	0.53 0.38	0.36 0.23	26.92 26.54	6.40 6.22	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	2.0
inches	0.17	0.020	0.13	0.068 0.051	0.021 0.015	0.014 0.009	1.060 1.045	0.25 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.078

#### Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFEF	RENCES	EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	EIAJ		PROJECTION	1350E DATE
SOT146-1			SC603			<del>-92-11-17</del> 95-05-24

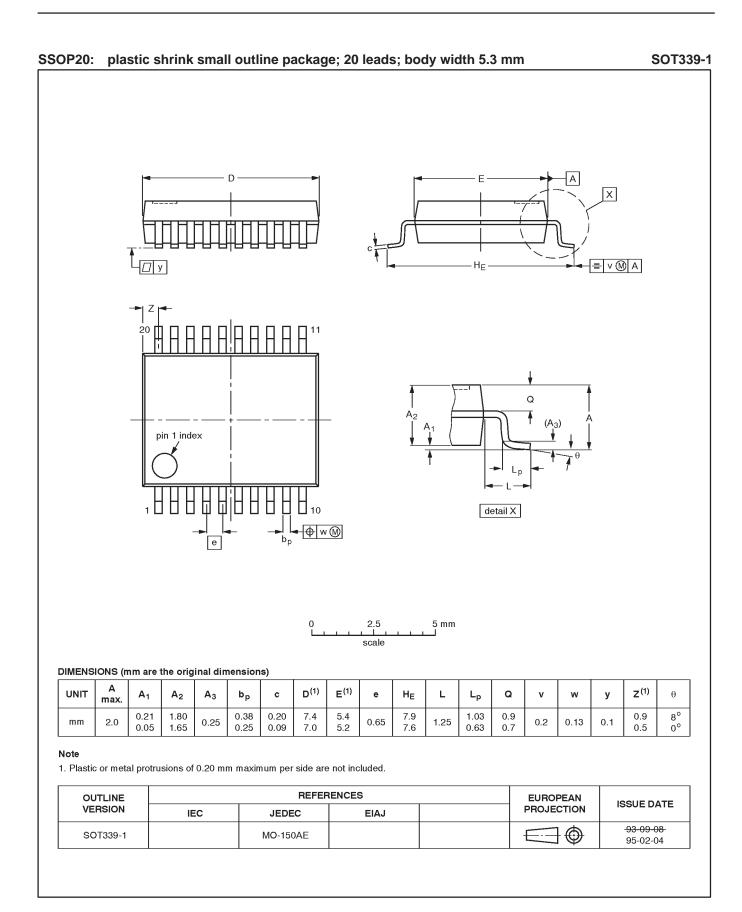
### 74ABT541



1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

OUTLINE		REFER	RENCES	EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT163-1	075E04	MS-013AC				<del>-92-11-17</del> 95-01-24

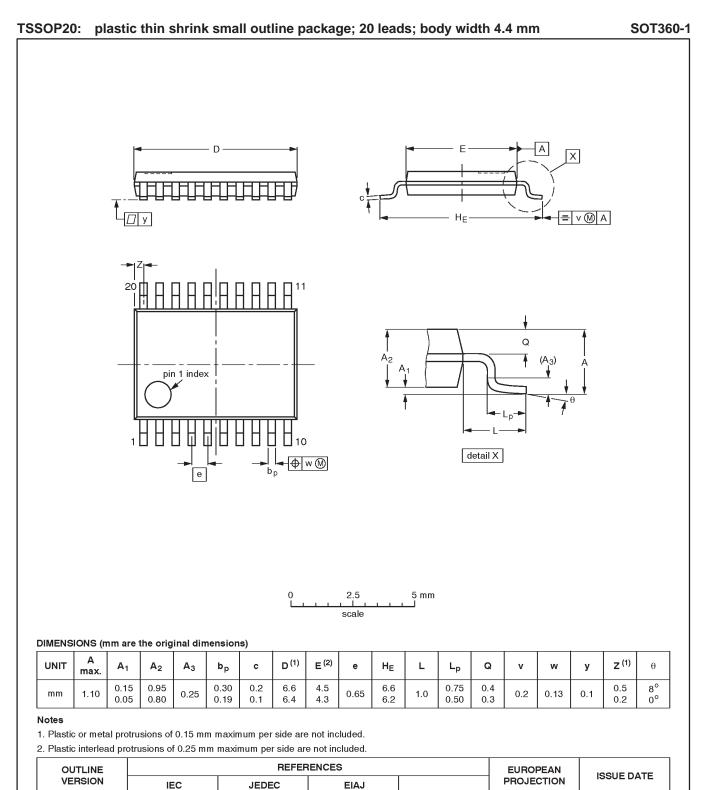
74ABT541



### 74ABT541

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95-02-04



74ABT541

NOTES

## 74ABT541

#### Data sheet status

Data sheet status	Product status	Definition <sup>[1]</sup>
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
Preliminary specification	Qualification	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make chages at any time without notice in order to improve design and supply the best possible product.
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[1] Please consult the most recently issued datasheet before initiating or completing a design.

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Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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